

Features

- -200V/-3.7A,
 $R_{DS(ON)} = 1280m\Omega(Typ.)@V_{GS}=-10V$
- Super High Dense Cell Design
- Reliable and Rugged

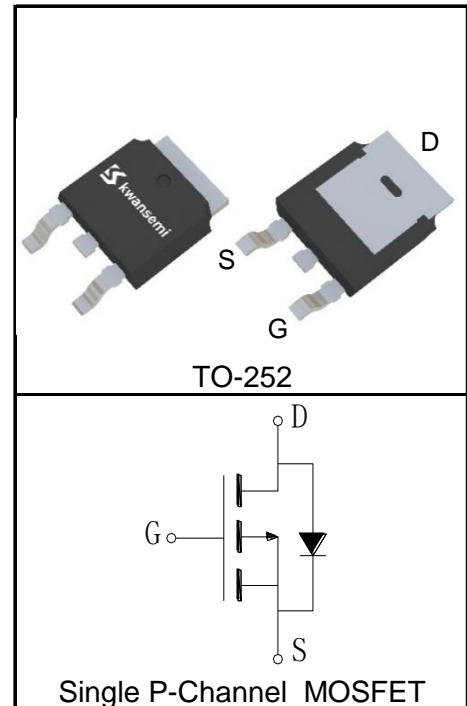
Applications

- Power Switching Application
- Load Switching



Halogen-Free

Pin Description



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Ratings ($T_C=25^\circ C$ Unless Otherwise Noted)				
V_{DSS}	Drain-Source Voltage	-200	V	
V_{GSS}	Gate-Source Voltage	± 20		
T_{Jmax}	Maximum Junction Temperature	150	$^\circ C$	
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	$^\circ C$	
I_S	Diode Continuous Forward Current	$T_C=25^\circ C$	-3.7	A
Mounted on Large Heat Sink				
$I_{DP}^{①}$	Pulse Drain Current	$T_C=25^\circ C$	-14	A
$I_D^{②}$	Continuous Drain Current($V_{GS}=-10V$)	$T_C=25^\circ C$	-3.7	A
		$T_C=100^\circ C$	-2.3	
P_D	Maximum Power Dissipation	$T_C=25^\circ C$	40	W
		$T_C=100^\circ C$	16	
$R_{\theta JC}$	Thermal Resistance-Junction to Case		3.1	$^\circ C/W$
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient		100	$^\circ C/W$
Drain-Source Avalanche Ratings				
$E_{AS}^{④}$	Avalanche Energy, Single Pulsed		128	mJ

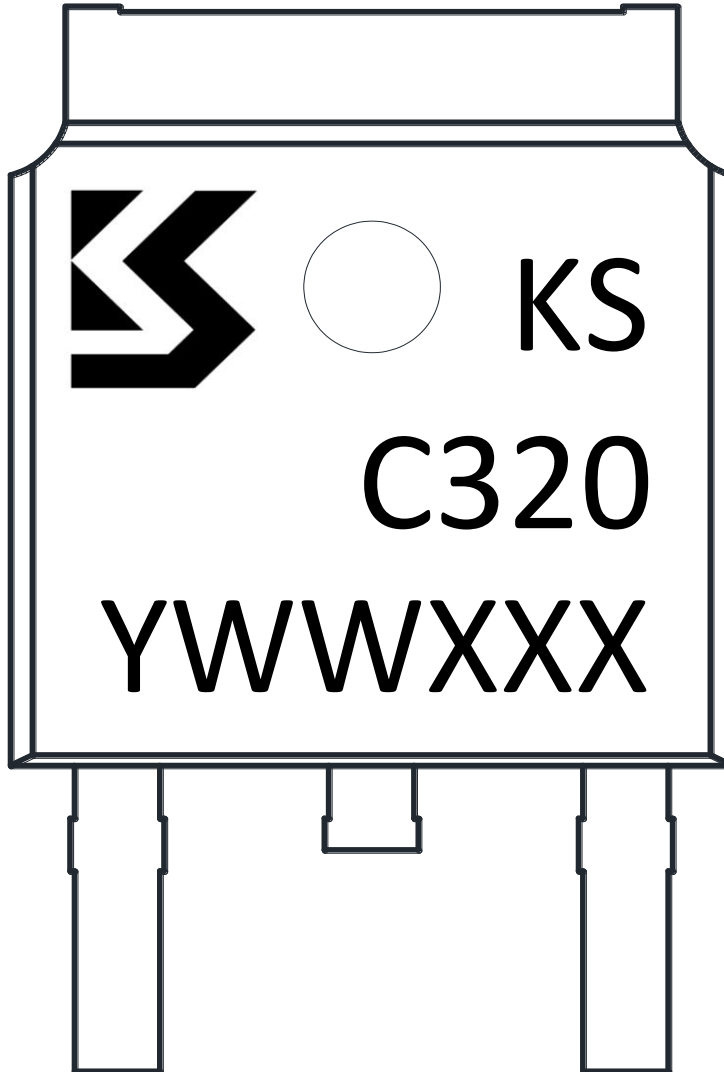
Electrical Characteristics ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KSC320DA			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=-250\mu A$	-200			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-200V, V_{GS}=0V$			-1	μA
		$T_J=125^\circ\text{C}$			-30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=-250\mu A$	-2	-3	-4	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$R_{DS(ON)}^{(5)}$	Drain-Source On-state Resistance	$V_{GS}=-10V, I_{DS}=-2A$		1280	1450	$m\Omega$
		$V_{GS}=-6V, I_{DS}=-2A$		1320	1700	$m\Omega$
Diode Characteristics						
$V_{SD}^{(5)}$	Diode Forward Voltage	$I_{SD}=-2A, V_{GS}=0V$		-0.83	-1.2	V
t_{rr}	Reverse Recovery Time	$I_{SD}=-2A, dI_{SD}/dt=-100A/\mu s$		66		ns
Q_{rr}	Reverse Recovery Charge			187		nC
Dynamic Characteristics⁽⁶⁾						
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$		6.5		Ω
C_{iss}	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=-100V,$ Frequency=1.0MHz		555		pF
C_{oss}	Output Capacitance			15		
C_{rss}	Reverse Transfer Capacitance			10		
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=-100V, I_{DS}=-2A,$ $V_{GEN}=-10V, R_G=3\Omega$		11		ns
t_r	Turn-on Rise Time			18		
$t_{d(OFF)}$	Turn-off Delay Time			31		
t_f	Turn-off Fall Time			19		
Gate Charge Characteristics⁽⁶⁾						
Q_g	Total Gate Charge	$V_{DS}=-100V, V_{GS}=-10V,$ $I_{DS}=-2A$		12		nC
Q_{gs}	Gate-Source Charge			2.4		
Q_{gd}	Gate-Drain Charge			3.7		

- Notes:
- ① Pulse width limited by safe operating area.
 - ② Calculated continuous current based on maximum allowable junction temperature.
 - ③ When mounted on 1 inch square copper board, $t \leq 10\text{sec}$. The value in any given application depends on the user's specific board design.
 - ④ Limited by T_{Jmax} , Starting $T_J = 25^\circ\text{C}$, $I_{AS} = -2A$, $L_{max} = 64\text{mH}$, $V_{DD} = -50V$, $R_G = 25\Omega$, $V_{GS} = -10V$. Part not recommended for use above this value. 100% Final Test at $I_{AS} = -2A$, $L = 30\text{mH}$.
 - ⑤ Pulse test; Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
 - ⑥ Guaranteed by design, not subject to production testing.

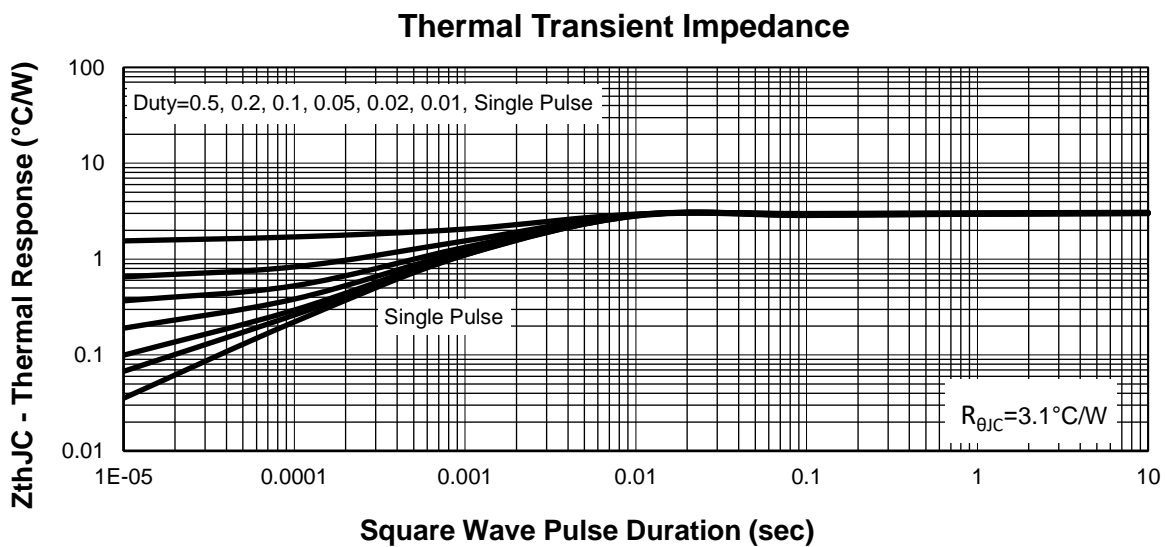
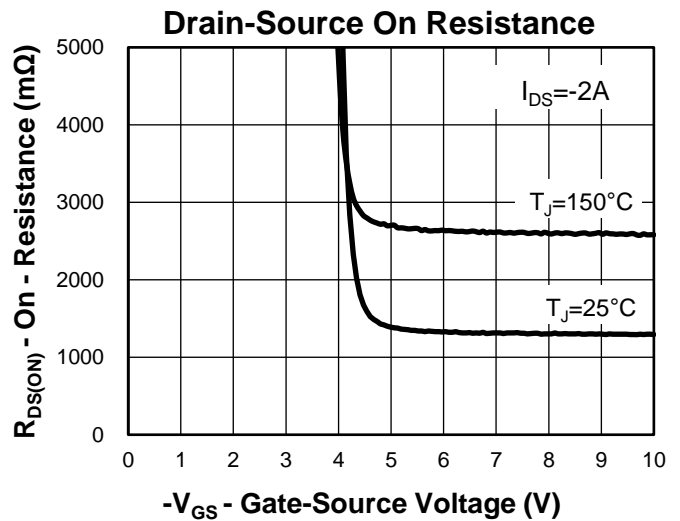
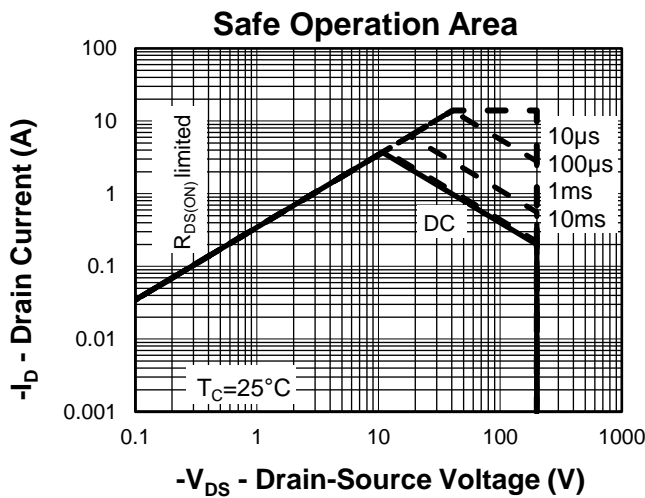
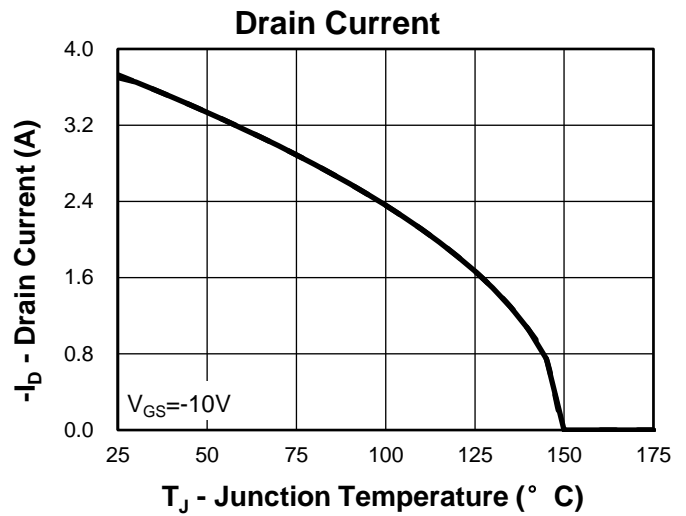
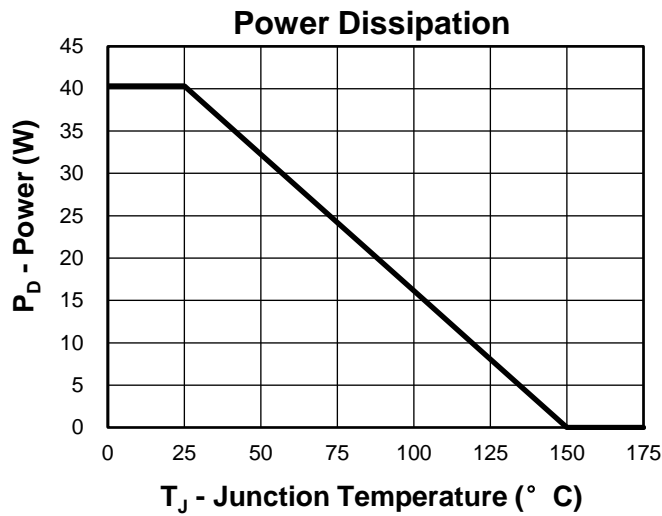
Ordering and Marking Information

Device	Package	Packaging	Quantity	Reel Size	Tape width
KSC320DA	TO-252	Tape&Reel	2500	13"	16mm

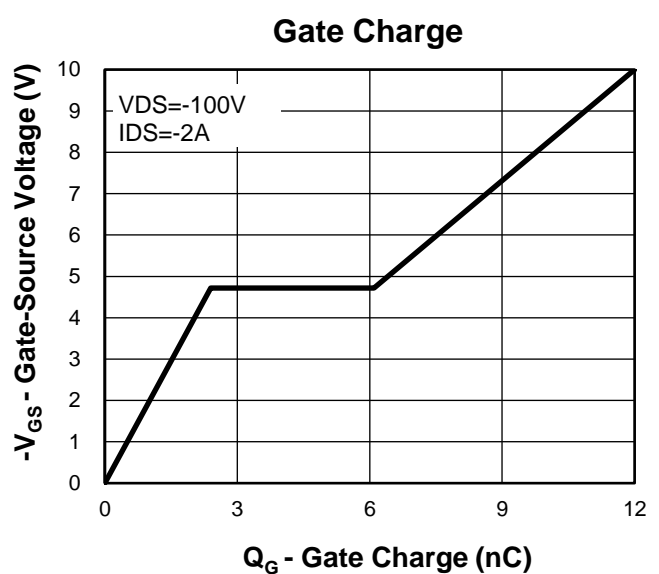
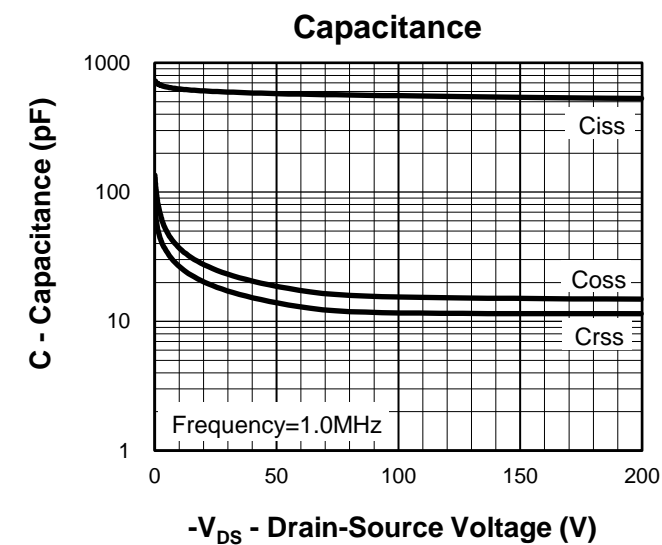
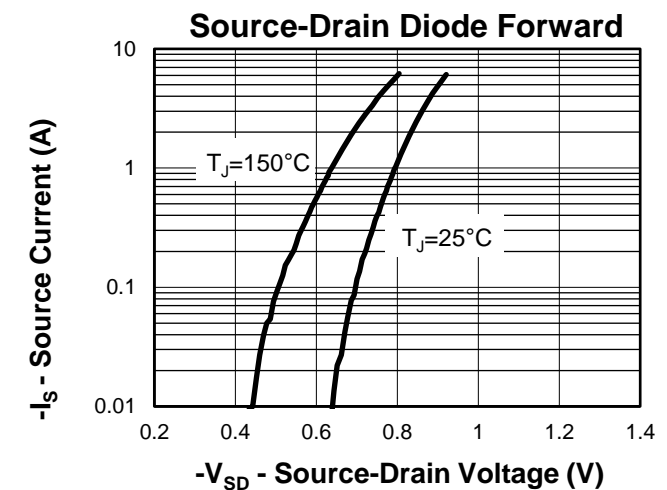
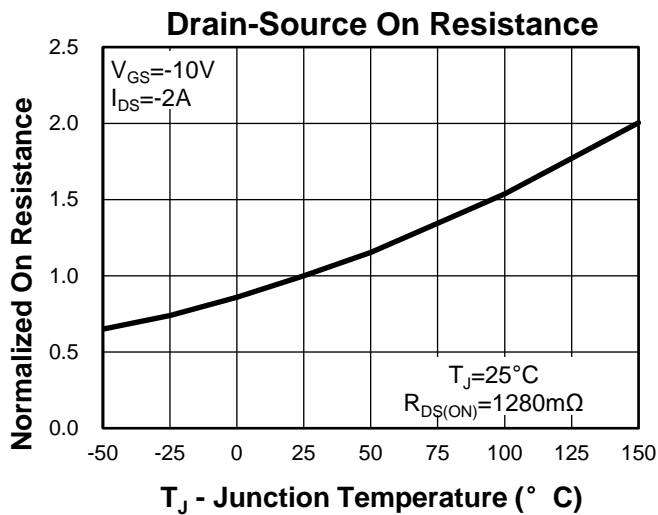
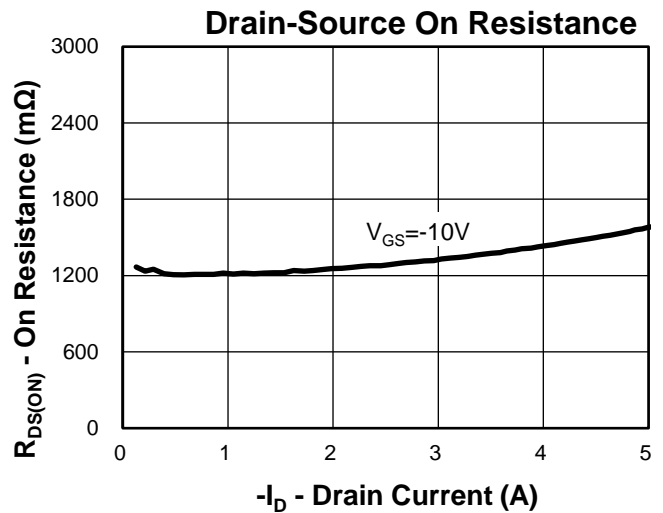
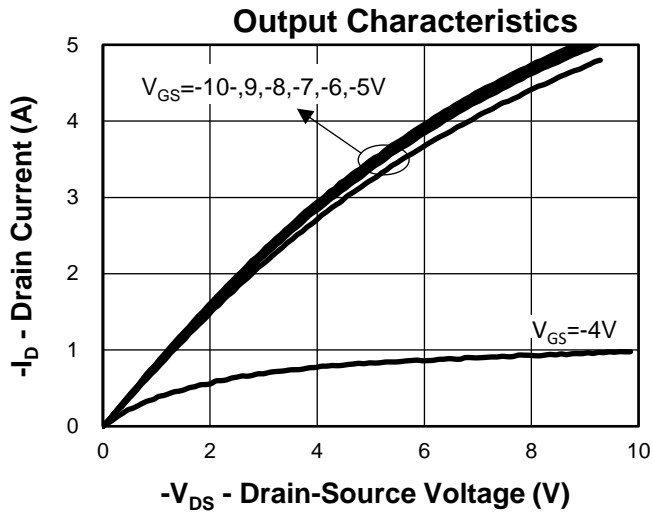


1st Line: Kwansemi LOGO, Kwansemi Code(KS)
2nd Line: Part Number(C320)
3rd Line: Lot Number(YWWXXX)

Typical Characteristics

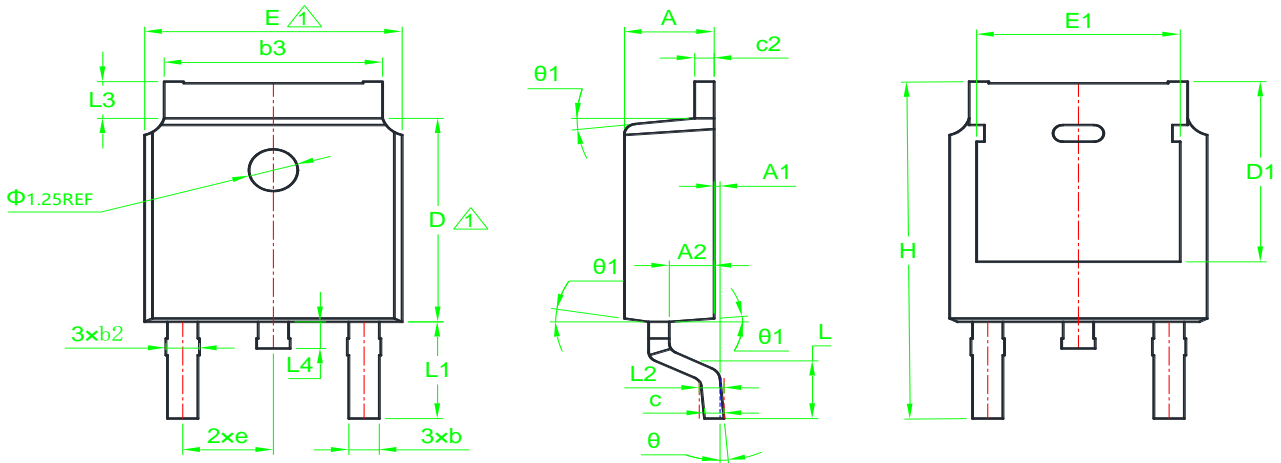


Typical Characteristics



Package Information

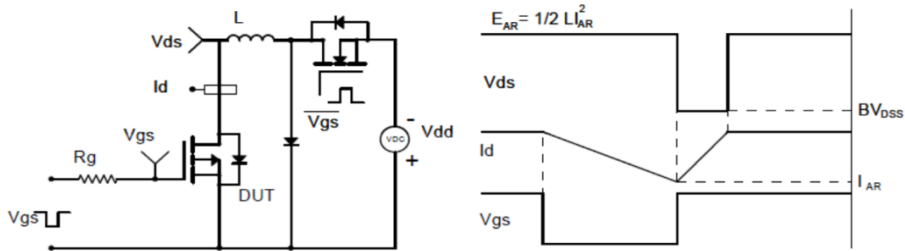
TO-252



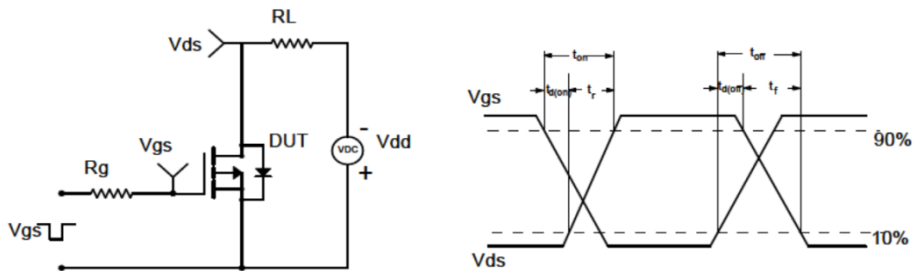
SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	2.20	2.30	2.38	0.087	0.091	0.094	E	6.40	6.60	6.70	0.252	0.260	0.264
A1	0.00	*	0.15	0.000	*	0.006	E1	4.55	*	5.15	0.179	*	0.203
A2	0.90	1.00	1.10	0.035	0.039	0.043	H	9.60	10.10	10.40	0.378	0.398	0.409
b	0.65	0.75	0.85	0.026	0.030	0.033	L	1.40	1.50	1.70	0.055	0.059	0.067
b2	0.72	*	0.90	0.028	*	0.035	L1	2.90REF			0.114REF		
b3	5.13	5.33	5.46	0.202	0.210	0.215	L2	0.508BSC			0.020BSC		
c	0.47	0.51	0.54	0.019	0.020	0.021	L3	0.90	*	1.25	0.035	*	0.049
D	6.00	6.10	6.20	0.236	0.240	0.244	L4	0.60	*	1.00	0.024	*	0.039
D1	5.25	5.35	5.60	0.207	0.211	0.220	θ	0°	*	10°	0°	*	10°
e	2.286BSC			0.090BSC			$\theta 1$	5°	*	9°	5°	*	9°

$\triangle 1$ Dimensions D and E do not include mold flash protrusions or gate burrs.

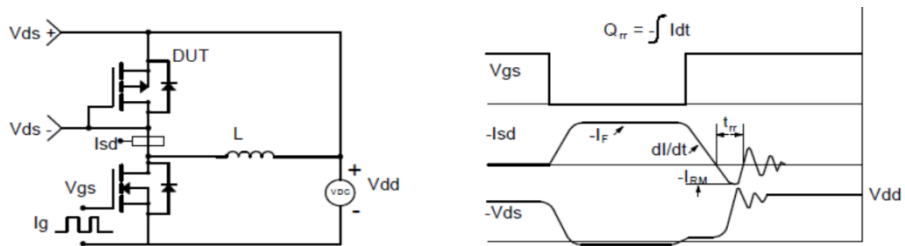
Avalanche Test Circuit and Waveforms



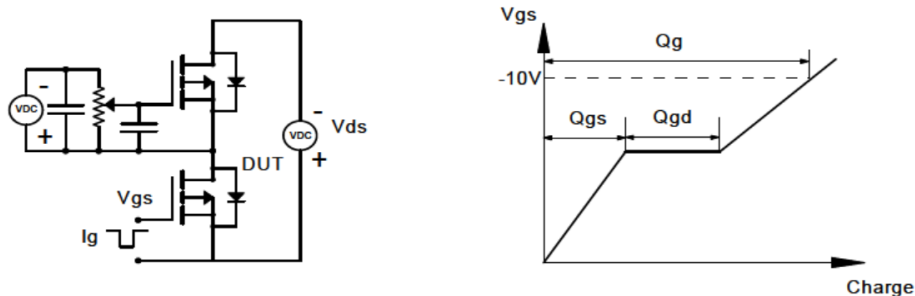
Switching Time Test Circuit and Waveforms



Diode Recovery Test Circuit and Waveforms



Gate Charge Test Circuit and Waveform



Customer Service

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